

Common-mode chokes, ring core 4.7 ... 10 mH, 200 ... 300 mA, 60  $^\circ\text{C}$ 

Series/Type: B82794C2 Date: January 2010

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## Common-mode chokes, ring core SMD Rated voltage 42 V AC/80 V DC Rated inductance 4.7 mH to 10 mH Rated current 200 mA to 300 mA

## Construction

Current-compensated ring core quad choke

Data and signal line chokes

- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Bifilar winding

#### **Features**

- Suitable for reflow soldering
- RoHS-compatible

## **Function**

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly

#### **Applications**

- Telecom interfaces
- ISDN systems

#### **Terminals**

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

#### Marking

- Marking on component: Manufacturer, ordering code inductance, graphic symbol, date of manufacture (YYWWD)
- Minimum data on reel: Manufacturer, ordering code, L value, current, quantity, date of packing

#### Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 250 pcs./reel





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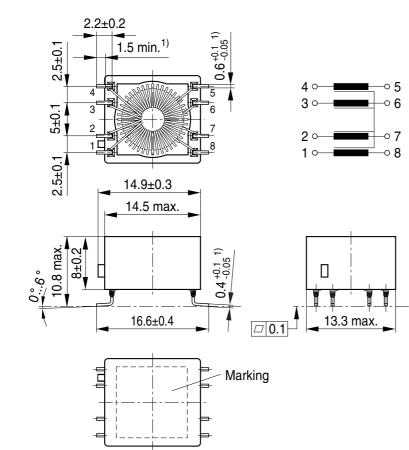
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Common-mode chokes, ring core

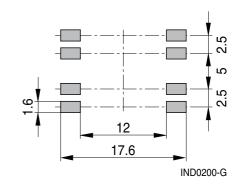
<u>SMD</u>

#### Dimensional drawing and pin configuration



Layout recommendation

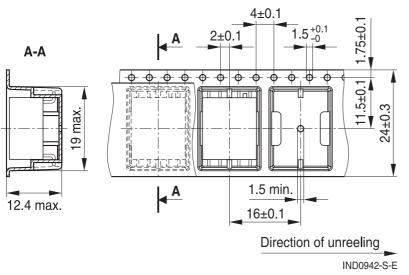
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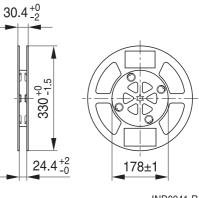
1) Soldering area

#### **Taping and packing**

Blister tape



Reel



IND0941-R

Dimensions in mm

Please read *Cautions and warnings* and *Important notes* at the end of this document.

3 01/10

IND0199-K-E

Dimensions in mm



Common-mode chokes, ring core

<u>SMD</u>

#### Technical data and measuring conditions

| Rated voltage V <sub>R</sub>            | 42 V AC (50/60 Hz) / 80 V DC   |  |  |
|---|--|--|--|
| Rated temperature T <sub>R</sub>        | 60 °C  |  |  |
| Rated current I <sub>R</sub>            | Referred to 50 Hz and rated temperature  |  |  |
| Rated inductance L <sub>R</sub>         | Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C Inductance is specified per winding.                           |  |  |
| Inductance tolerance                    | −30%/+50% at 20 °C   |  |  |
| Inductance decrease $\Delta L/L_0$      | < 10% at DC magnetic bias with I <sub>R</sub> , 20 °C  |  |  |
| Stray inductance L <sub>stray,typ</sub> | Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C, typical values  |  |  |
| DC resistance R <sub>typ</sub>          | Measured at 20 °C, typical values, specified per winding   |  |  |
| Solderability (lead-free)               | Sn96.5Ag3.0Cu0.5: (245 $\pm$ 5) °C, (3 $\pm$ 0.3) s<br>Wetting of soldering area $\geq$ 95%<br>(to IEC 60068-2-58) |  |  |
| Resistance to soldering heat            | (260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)   |  |  |
| Climatic category                       | 40/125/56 (to IEC 60068-1)   |  |  |
| Storage conditions (packaged)           | –25 °C … +40 °C, ≤75% RH   |  |  |
| Weight                                  | Approx. 2.5 g  |  |  |
|   |  |  |  |

#### Characteristics and ordering codes

| L <sub>R</sub> | L <sub>stray,typ</sub> | I <sub>R</sub> | R <sub>typ</sub> | V <sub>test</sub> | Ordering code   |
|----------------|------------------------|----------------|------------------|-------------------|-----------------|
| mH             | nH                     | mA             | mΩ               | V DC, 2 s         |                 |
| 4.7            | 350                    | 300            | 900              | 750               | B82794C2475N465 |
| 10             | 900                    | 200            | 1400             | 750               | B82794C2106N465 |



#### Common-mode chokes, ring core

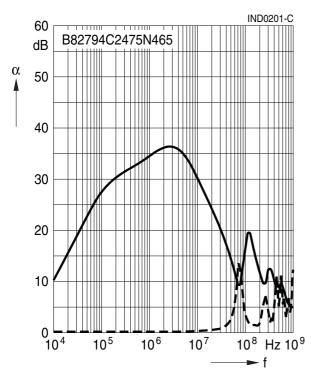
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**Insertion loss**  $\alpha$  (typical values at  $|Z| = 50 \Omega$ , 20 °C)

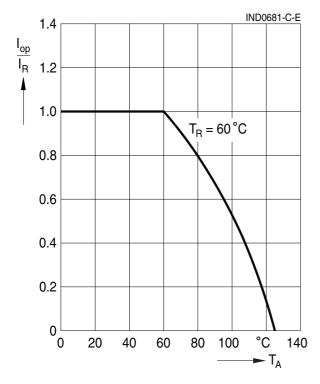
------ asymmetrical, all branches in parallel (common mode)

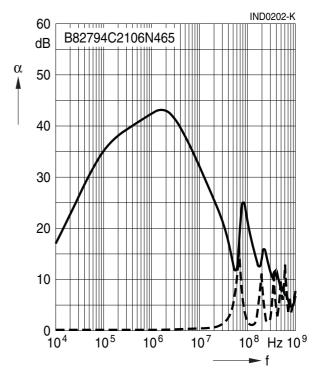
---- symmetrical (differential mode)

 $L_{R} = 4.7 \text{ mH}$ 



Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature









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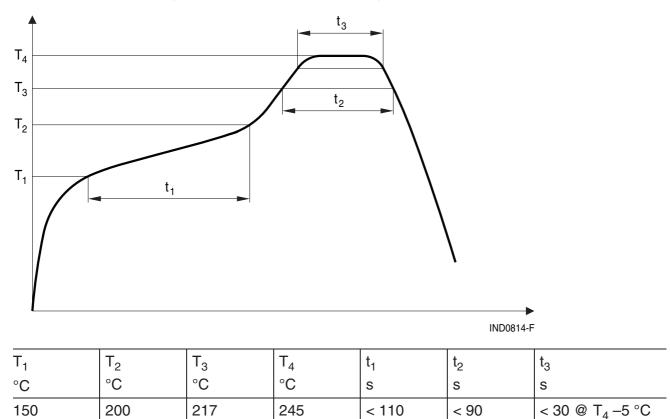
Data and signal line chokes

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#### Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



Time from 25 °C to  $T_4$ : max 300 s Maximal numbers of reflow cycles: 3



#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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